						F	REVISI	ONS										
LTR				DESCF	RIPTIO	N			DATE (YR-MO-DA)			APPROVED						
A	Add case outline S to device type 01. Add device type 02 to draw outlines R, S, and 2. Add vendors CAGE 75569 and 27014 to de Add vendors CAGE 61722 and 75569 to device type 02. Editoria table I and throughout drawing.						to devi	ce type	e 01.		89-12-07 Michael A			l A. Fry	e			
В	boilerp	otes to figure plate to curre es throughou	e 4, switching ent requireme ut jak	wavefo nts as s	rms an pecifie	d test o d in MII	circuit. L-PRF-	Update 38535.	e the Editor	ial	06-04-18			Т	Thomas M. Hess		SS	
С	Add fo	otnote <u>4</u> / to	I <sub>cc</sub> test in tab	le I. – ja	ık							10-0	1-06		т	homas	M. He	SS
REV																		
SHEET																		
REV																		
SHEET																		
REV STATUS	;	ł	REV		С	С	С	С	С	С	С	С	С	С				
OF SHEETS			SHEET		1	2	3	4	5	6	7	8	9	10				
PMIC N/A PREPARED BY James E. Nicklaus STANDARD CHECKED BY Monica L. Poelking						DI		DLUM		OHIO	0 43	R COL 218-39 a.mil		US				
-		-				-												
FOR L DEPA	THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS		APPROVED BY Michael A. Frye				MICROCIRCUIT, DIGITAL, FAST CMOS, OCTAL D-TYPE FLIP-FLOP WITH CLEAR, TTL COMPATIBLE INPUTS, MONOLITHIC SILICON											
AND AGENCIES OF THE DEPARTMENT OF DEFENSE			DRAWING 87-	APPR0 11-16	JVAL L	JAIE												
			REVISION					CI	ZE	C^	GE CC		i					
AM	/ISC N/A		REVISION		С				∠⊨ <b>\</b>		6726			5	962-	876	56	
								SHE	ET	<u>I</u>	1	OF	10					

# 1. SCOPE

1.1 <u>Scope</u>. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A. 1.2 Part or Identifying Number (PIN). The complete PIN is as shown in the following example: 5962-87656 01 Drawing number Device type Case outline Lead finish (see 1.2.1) (see 1.2.2) (see 1.2.3) 1.2.1 <u>Device type(s)</u>. The device type(s) identify the circuit function as follows: Generic number Circuit function Device type Octal D-type flip-flop with clear, TTL compatible inputs Octal D-type flip-flop with clear, TTL compatible inputs 01 54FCT273 02 54FCT273A 1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows: Package style Outline letter Descriptive designator Terminals R GDIP1-T20 or CDIP2-T20 20 Dual-in-line S 2 GDFP2-F20 or CDFP3-F20 20 Flat pack CQCC1-N20 20 Square leadless chip carrier 1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A. 1.3 Absolute maximum ratings. 1/ Supply voltage range (V<sub>CC</sub>)...... -0.5 V dc to +6.0 V dc 1.4 Recommended operating conditions. Device type 02 ...... 2.0 ns Minimum CP pulse width, high or low  $(t_{w1})$ : Device type 01 ...... 7.0 ns Device type 02 ..... Minimum removal time, MR to CP (t<sub>REM</sub>): ..... 6.0 ns 1/ Unless other wise specified, all voltages are referenced to ground. SIZE STANDARD 5962-87656 Α MICROCIRCUIT DRAWING DEFENSE SUPPLY CENTER COLUMBUS **REVISION LEVEL** SHEET COLUMBUS, OHIO 43218-3990 С 2

#### 2. APPLICABLE DOCUMENTS

2.1 <u>Government specification, standards, and handbooks</u>. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

#### DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.

MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

#### DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.

MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at https://assist.daps.dla.mil/quicksearch/ or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

#### 3. REQUIREMENTS

3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

- 3.2.1 <u>Case outlines</u>. The case outlines shall be in accordance with 1.2.2 herein.
- 3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.
- 3.2.3 <u>Truth table</u>. The truth table shall be as specified on figure 2.
- 3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.
- 3.2.5 Switching waveforms and test circuit. The switching waveforms and test circuit shall be as specified on figure 4.

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3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.

3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 <u>Marking</u>. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.

3.5.1 <u>Certification/compliance mark</u>. A compliance indicator "C" shall be marked on all non-JAN devices built in compliance to MIL-PRF-38535, appendix A. The compliance indicator "C" shall be replaced with a "Q" or "QML" certification mark in accordance with MIL-PRF-38535 to identify when the QML flow option is used.

3.6 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 <u>Notification of change</u>. Notification of change to DSCC-VA shall be required for any change that affects this drawing.

3.9 <u>Verification and review</u>. DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

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Test	Symbol	ol Conditions $-55^{\circ}C \le T_{C} \le +125^{\circ}C$ $V_{CC} = 5.0 V dc \pm 10\%$			Device type	Group A subgroups	Limits		Unit
			rwise specified		-71		Min Max		-
High level output voltage	V <sub>OH</sub>	$V_{IL} = 0.8 V$	I <sub>OH</sub> = -300 μA	4.5 V	All	1, 2, 3	4.3		V
		V <sub>IH</sub> = 2.0 V	I <sub>он</sub> = -12 mA	_			2.4		
_ow level output voltage	V <sub>OL</sub>	V <sub>IL</sub> = 0.8 V	I <sub>OL</sub> = +300 μA	4.5 V	All	1, 2, 3		0.2	V
	-	V <sub>IH</sub> = 2.0 V	I <sub>OL</sub> = +32 mA					0.5	
nput clamp voltage	VIK	I <sub>IN</sub> = -18 mA		4.5 V	All	1		-1.2	V
High level input current	I <sub>IH</sub>	V <sub>IN</sub> = 5.5 V		5.5 V	All	1, 2, 3		5.0	μA
ow level input current	IIL	V <sub>IN</sub> = GND		5.5 V	All	1, 2, 3		-5.0	μA
Short circuit current	I <sub>OS</sub>	V <sub>OUT</sub> = GND		5.5 V	All	4	-60		mA
Quiescent power supply current (CMOS inputs)	<u>1</u> /	$V_{IN} \leq 0.2 \text{ V or V}$ $f_i = f_{CP} = 0 \text{ MHz}$		5.5 V	All	1, 2, 3		1.5	mA
Quiescent power supply current (TTL inputs)	Δl <sub>CC</sub> 2/	V <sub>IN</sub> = 3.4 V		5.5 V	All	1, 2, 3		2.0	mA
Dynamic power supply current	I <sub>CCD</sub> <u>3</u> / <u>4</u> /	$\label{eq:mr} \begin{array}{l} \overline{\text{MR}} = V_{\text{CC}} \\ \text{Outputs open} \\ \text{One bit toggling} \\ V_{\text{IN}} \leq 0.2 \text{ V or V} \end{array}$	g, 50% duty cycle $f_{\rm IN} \ge 5.3 \ {\rm V}$	5.5 V	All	<u>3</u> /		0.25	mA/ MHz
otal power supply current	I <sub>CC</sub> <u>4</u> / <u>5</u> /	$V_{IN} \le 0.2 \text{ V or V}$ $f_{CP} = 10 \text{ MHz}$ Outputs open One bit toggling 50% duty cycle $\overline{MR} = V_{CC}$	${\cal V}_{\text{IN}} \ge 5.3 \text{ V}$ g at f <sub>i</sub> = 5 MHz	5.5 V	All	1, 2, 3		4.0	mA
		$V_{IN}$ = 3.4 V or V f <sub>CP</sub> = 10 MHz Outputs open eight bits toggli 50% duty cycle MR = V <sub>CC</sub>	ng at f <sub>i</sub> = 2.5 MHz	5.5 V	All	1, 2, 3		6.0	mA
nput capacitance	CIN	See 4.3.1c			All	4		10	pF
nput capacitance Functional tests	C <sub>OUT</sub>	See 4.3.1c See 4.3.1d		4.5 V	All	4 7, 8		12	pF
Propagation delay time, CP to On	t <sub>PHL1</sub> , t <sub>PLH1</sub>	$C_L = 50 \text{ pF} \pm 10$ $R_L = 500\Omega \pm 5\%$		4.5 V	All 01	9, 10, 11	2.0	15.0	ns
	<u>6</u> /	R <sub>T</sub> = 50Ω	•	4.5 V	02	9, 10, 11	2.0	8.3	1
Propagation delay time, MR to On	t <sub>PHL2</sub> <u>6</u> /	See figure 4		4.5 V	01	9, 10, 11	2.0	15.0	ns
	<u> </u>			4.5 V	02	9, 10, 11	2.0	8.3	1

 Not more than one output should be shorted at one time, and the duration of the short circuit condition should not excee 1 second.

 $\underline{2}$ / For TTL driven inputs, V<sub>IN</sub> = 3.4 V; all other inputs are equal to V<sub>CC</sub> or GND.

3/ This parameter is not directly testable, but is derived for use in total power supply calculations.

- <u>4</u>/ For I<sub>CC</sub> tests, in an ATE environment, the effect of parasitic output capacitive loading from the test environment must be taken into account, as its effect is not intended to be included in the test results. The impact must be characterized and appropriate offset factors must be applied to the test result."
- $\frac{5}{I_{CC}} = I_{CCQ} + (\Delta I_{CC} D_H N_T) + I_{CCD} (f_{CP}/2 + f_i N_i), \text{ where: } D_H = \text{duty cycle for TTL input high; } N_T = \text{number of TTL inputs at } D_H; \\ f_i = \text{input frequency in MHz; } N_i = \text{number of inputs at } f_i; \ f_{CP} = \text{clock frequency in MHz}.$

6/ The minimum limits are guaranteed, if not tested, to the specified limits in table I.

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Device types	01 and 02
Case outlines	R, S, and 2
Terminal number	Terminal symbol
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20	MR 00 D0 D1 02 D2 D3 03 GND CP 04 D4 D5 05 06 D6 D7 07 V <sub>CC</sub>

# FIGURE 1. Terminal connections.

Operating		Inputs		Outputs
mode	MR	CP	Dn	On
Reset (clear)	L	Х	Х	L
Load "1"	Н	$\uparrow$	h	Н
Load "0"	Н	$\uparrow$	Ι	L

L = Low voltage level

H = High voltage level

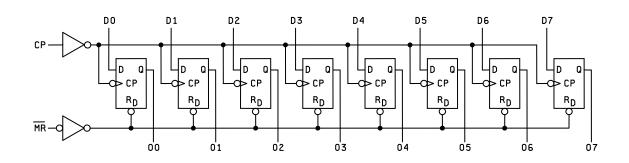
 $\uparrow$  = Low-to-high transition of the clock

h = High voltage level one setup time prior to the low-to-high clock transition

I = Low voltage level one setup time prior to the low-to-high clock transition X = Don't care

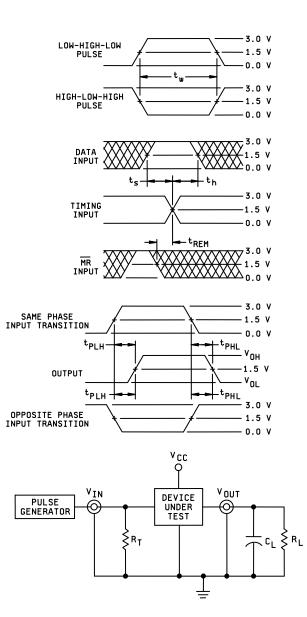
FIGURE 2. Truth table.

	VING A 5962-87656
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## NOTES:

- 1.  $R_L$  = 500 $\Omega$  or equivalent.
- 2.  $R_T$  = 50 $\Omega$  or equivalent, terminal resistance which should be equal to  $Z_{OUT}$  of the pulse generator.
- 3.  $C_L$  = 50 pF or equivalent (includes test jig and probe capacitance).
- 4. Pulse generator for all pulses:  $t_f~\leq$  2.5 ns;  $t_r$   $\leq$  2.5 ns.

FIGURE 4. Switching waveforms and test circuit.

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#### 4. VERIFICATION

4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

- a. Burn-in test, method 1015 of MIL-STD-883.
  - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
  - (2)  $T_A = +125^{\circ}C$ , minimum.
- b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

-	
MIL-STD-883 test requirements	Subgroups
	(in accordance with
	MIL-STD-883, method 5005, table I)
Interim electrical parameters (method 5004)	
Final electrical test parameters (method 5004)	1*, 2, 3, 7, 8, 9, 10, 11
Group A test requirements (method 5005)	1, 2, 3, 4, 7, 8, 9, 10, 11
Groups C and D end-point	1, 2, 3
electrical parameters	
(method 5005)	

#### TABLE II. Electrical test requirements.

\* PDA applies to subgroup 1.

4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

## 4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (C<sub>IN</sub> and C<sub>OUT</sub> measurements) shall be measured only for the initial test and after process or design changes which may affect capacitance. Test all applicable pins on 5 devices with zero failures.
- d. Subgroup 7 and 8 tests shall include verification of the truth table as specified on figure 2.

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#### 4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
  - (1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
  - (2)  $T_A = +125^{\circ}C$ , minimum.
  - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

#### 5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractorprepared specification or drawing.

6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal.

6.4 <u>Record of users</u>. Military and industrial users should inform Defense Supply Center Columbus (DSCC) when a system application requires configuration control and the applicable SMD. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0544.

6.5 <u>Comments</u>. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0547.

6.6 <u>Approved sources of supply</u>. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

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#### STANDARD MICROCIRCUIT DRAWING BULLETIN

#### DATE: 10-01-06

Approved sources of supply for SMD 5962-87656 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DSCC maintains an online database of all current sources of supply at http://www.dscc.dla.mil/Programs/Smcr/.

Standard	Vendor	Vendor
microcircuit drawing	CAGE	similar
PIN <u>1</u> /	number	PIN <u>2</u> /
5962-8765601RA	0C7V7	54FCT273DMQB
5962-8765601SA	0C7V7	54FCT273FMQB
5962-87656012A	0C7V7	54FCT273LMQB
5962-8765602RA	<u>3</u> /	54FCT273A
5962-8765602SA	<u>3</u> /	54FCT273A
5962-87656022A	<u>3</u> /	54FCT273A

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed, contact the vendor to determine its availability.
- <u>2</u>/ <u>Caution</u>. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- $\underline{3}$ / Not available from an approved source of supply.

Vendor CAGE number Vendor name and address

0C7V7

QP Semiconductor 2945 Oakmead Village Court Santa Clara, CA 95051

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